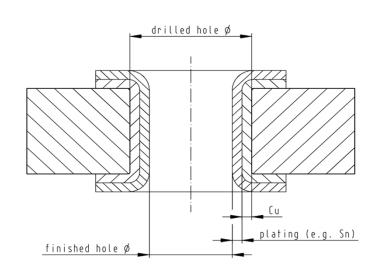


**DIN** power female connector

HARTING



In addition to the hot-air-level (HAL), other PCB surfaces are getting more important. Due to their different properties - such as mechanical strength and coefficient of friction - we recommend the following configuration of PCB through holes.



## **Assembly instructions**

It is highly recommended to use HARTING press-in tools to ensure a reliable press-in process. Please refer to the catalogue for tools, machines and further information about the press-in process.

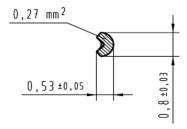
#### **Soldering instructions**

The connectors should be protected when being soldered in a dip, flow or film soldering baths. Otherwise, they might become contaminated as a result of soldering operations or deformed as a result of overheating.

(1) For prototypes and short runs protect the connectors with an industrial adhesive tape, e.g. Tesaband 4331 (www.tesa.de). Cover the underside of the connector moulding and the adjacent parts of the pcb as well as the open sides of the connector. This will prevent heat and gases of the soldering apparatus from damaging the connector. About 140 + 5 mm of the tape should suffice.

(2) For large series a jig is recommended. Its protective cover with a fast action mechanical locking device shields the connectors from gas and heat generated by the soldering apparatus. As an additional protection a foil can be used for covering the parts that should not be soldered.

## **Cross section of solder pins**



				Date	Name	®
			Detail.	28/04/11	mte	HARTING
			Inspec.	28/04/11	TD	HAKTING
EC01557			Stand.			
Mod.	Date	Name	HARTING Electronics GmbH & Co. KG			

Design	IEC 60603-2 types: D, E female		
No. of contacts	max. 48		
Contact spacing	5,08 mm		
Test voltage	1550V		
Contact resistance	<u>&lt;</u> 15 mOhm		
Insulation resistance	$\geq$ 10 <sup>12</sup> Ohm		
Working current	6 A@20°C (see derating diagram)		
Temperature range	-55℃ +125℃		
	-40℃ +105℃ for press-in connectors (due to limit ations of PCB-material)		
Termination technology	solder pins, solder lugs, wirewrap, press-in		
Clearance	min. 3,0 mm		
Creepage	min. 3,0 mm		
Insertion and withdrawal force	32pol. ≤ 50N		
	48pol. ≤ 75N		
	- PL1 acc. to IEC 60 603-2 => 500 mating cycles		
Mating cycles	- PL2 acc. to IEC 60 603-2 => 400 mating cycles		
	- PL3 acc. to IEC 60 603-2 => 50 mating cycles		
UL file	E102079		
RoHS - compliant	Yes		
Leadfree	Yes		
Hot plugging	No		
Color	RAL 7032 (grey)		
UL classification	UL 94-V0		
Material group acc. IEC 60664-1	IIIa (175 <u>&lt;</u> CTI < 400)		
NFF classification	I3, F4		
Contact material			
Contact material	Copper alloy		
Plating termination zone	Sn over Ni for solder pins & lugs Ni for wirewrap & press-in		
Plating contact zone	Au over Ni		
Derating diagram acc. to IEC 60512-5	5 (Current carrying capacity)		
	Α		
The current carrying capacity is limited temperature of materials for inserts and cor			
terminals. The current capacity curve is valid for c	continuous, non $\overline{<}$ 4		
interrupted current loaded contacts of con simultaneous power on all contacts is given, wi the maximum temperature.	nnectors when $\overline{v}$		
	C 60512-5		

0 20

40

60

Temperature [℃]

80

100

120 °C

Tin plated PCB (HAL) acc. to EN	Drilled hole Ø	1,15±0,025 mm
	Cu	min. 25 µm
60352-5	Sn	max. 15 µm
	plated hole Ø	0,94 – 1,09 mm
Chemical tin plated PCB	Drilled hole Ø	1,15±0,025 mm
	Cu	min. 25 µm
	Sn	min. 0,8 µm
	plated hole Ø	1,00 – 1,10 mm
Gold /Nickel plated PCB	Drilled hole Ø	1,15±0,025 mm
	Cu	min. 25 µm
	Ni	3-7 μm
	Au	0,05-0,12 µm
	plated hole Ø	1,00 – 1,10 mm
Silver plated PCB	Drilled hole Ø	1,15±0,025 mm
	Cu	min. 25 µm
	Ag	0,1 – 0,3 µm
	plated hole Ø	1,00 – 1,10 mm
Copper plated PCB	Drilled hole Ø	1,15±0,025 mm
	Cu	min. 25 µm
(OSP)	plated hole Ø	1,00 – 1,10 mm

# Cross section of wirewrap posts



Technical data sheet
DIN power female connector
DS 09 04 210 00 01